Air Conditioner Outdoor Unit Circuit Reference Guide

RD219-RGUIDE-02

Toshiba Electronic Devices & Storage Corporation

Table of Contents

1.	Int	roduction	4
2.	Spe	ecifications	5
2.1.	Blo	ock Diagram	6
2.2.	Ар	pearance and Component Layout	7
3.	Sch	ematic, Bill of Materials, and PCB Pattern	11
3.1.	Sc	hematic	11
3.2.	Bil	l of Materials	11
3.3.	PC	B Pattern	11
4.	Оре	eration	14
4.1.	Na	mes and Functions of Components	14
4.1	l.1.	Power Supply Input Terminals (AC-L, AC-N, GND_EARTH)	14
4.1	L.2.	Fan Motor Connector (CN10)	15
4.1	L.3.	Compressor Connectors (CN-CMP)	15
4.1	L.4.	Four-Way Valve Connectors (CN-VL1, CN-VN1)	16
4.1	L. 5 .	Electric Expansion Valve Connector (CN11)	16
4.1	L.6.	Indoor Unit Communication Connector (CN-COM)	17
4.1	L. 7 .	AC Power Supply Fuse (F1)	17
4.1	L .8 .	Temperature Sensor Connectors (CN5, CN8, CN9)	18
4.1	L .9.	UART Connector (CN3)	19
4.1	L.10.	SWD Connector (CN1)	20
4.1	L.11.	DAC Output Connector (CN2)	20
4.1	L.12.	LEDs (LED1, LED2, LED3, LED4, LED5)	21
4.1	L.13.	Test Pins (TP)	22
4.2.	Ор	eration	23
4.2	2.1.	Preparation	23
4.2	2.2.	Operation Checking Procedure	24
© 2024 Toshi	ba Electr	onic Devices & Storage Corporation 2 / 28	2024-01-05

4.2.3	3. Operation	During Abnor	mality Dete	ction			25
4.3.	Precautions (To Prevent Ele	ectric Shock,	Burn Inj	ury, etc.))	26

1. Introduction

This Reference Guide (hereinafter referred to as this guide) describes the specifications and operation procedures of the Air Conditioner Outdoor Unit Circuit (hereinafter referred to as this design).

Recently, low power consumption has been required for outdoor air conditioner units. And brushless motors driven by inverters using high efficiency switching devices have become common for compressors and fans. In addition, sensorless vector control is being increasingly used for motor control, as equipment is required to have low cost, high efficiency, and low motor noise. In addition, the demand for smaller circuit boards in equipment is also increasing.

This design uses a low on-resistance power MOSFET <u>TK20A60W5</u> for the compressor drive inverter to achieve a highly efficient compressor drive. In addition, a highly efficient and compact fan motor drive is achieved by using an intelligent power device <u>TPD4204F</u> with a built-in gate driver and inverter circuit for the fan motor drive. PFC inductors are also downsized by using IGBT device <u>GT30J65MRB</u> that has low switching losses and can operate at high switching frequencies in a switching PFC power supply circuit. Furthermore, by using the microcontroller <u>TMPM4KLFYAUG</u> equipped with a vector engine, sensorless vector control of the fan motor and the compressor as well as PFC power supply control are realized with a single microcontroller, which simplifies and reduces the size of the outdoor unit circuit.

In addition, a transistor array <u>TBD62003AFG</u> is used as a valve control driver, a photocoupler <u>TLP785</u> is used as an insulating interface for communication between outdoor units and indoor units, a SiC Schottky barrier diode <u>TRS24N65FB</u> is used as a PFC diode, a <u>TC75W59FU</u> is used as an operational amplifier for signal amplification, and a <u>TA75S393F</u> is used as a comparator for detecting abnormalities.

2. Specifications

Table 2.1 lists the main specifications of the circuit of this design.

Item	Description			
Input Power Supply	AC220 V (Typ.)			
Control Power Supply	DC15 V, DC12 V, DC5 V (internally generated)			
	Brushless motor: 2 ch			
Compatible Motors and	Fan motor (motor ch.0)			
Control Methods	Compressor (motor ch.1)			
	Sensorless vector control			
	PFC: 1500 W			
Rated Output	Fan motor: 200 W			
	Compressor: 1300 W			
Cwitching Eroquonov	PFC: 60 kHz			
Switching Frequency	Fan motor: 16 kHz			
(Software Setting)	Compressor: 6.5 kHz			
	AC input overcurrent (fuse 20 A)			
	PFC overcurrent (18 A)			
Hardware Protection	Fan motor overcurrent (1.4 A)			
Features	Compressor overcurrent (17 A)			
	Overheat and power supply voltage drop (driver function of fan			
	motor drive)			
Board Size	160 × 220 × 80 mm			
Poord Configuration	FR-4 Double-sided 1.6 mm Thickness, Copper Foil Thickness 70 µm			
Dudi u Curingui ation	one-side silk, one-side mounting			
Cooling System	(Forced air cooling by an outdoor unit fan)			
	Valve control: 5 ch (four-way valve x 1 ch, electric expansion valve			
	x 4 ch)			
	Indoor unit communication: 1 ch			
I/O Intorfaco	Temperature sensor input: 6 ch			
	UART: 1 ch (Host MCU communication)			
	Synchronous communication: 1 ch (for DAC output)			
	SWD input/output: 1 ch (for debugging)			
	LED: 4 pcs. (status display), 1 pc. (power ON display)			

2.1. Block Diagram

Figure 2.1 shows the block diagram of this design.



Fig. 2.1 Block Diagram of the Air Conditioner Outdoor Unit Circuit

2.2. Appearance and Component Layout

Figures 2.2, 2.3, and 2.4 show the external appearance of this design, and Figures 2.5 and 2.6 show the PCB layout.



Fig. 2.2 Front View of the Air Conditioner Outdoor Unit Circuit Board

RD219-RGUIDE-02



Fig. 2.3 Side View of the Air conditioner Outdoor Unit Circuit Board



g. 2.4 Side View of the Air Conditioner Outdoor Unit Circuit Boar (with Heat Sink Installed)



Fig. 2.5 PCB Layout of the Main Components of the Air Conditioner Outdoor Unit Circuit (Top)



Fig. 2.6 PCB Layout of the Main Components of the Air Conditioner Outdoor Unit Circuit (Bottom)

3. Schematic , Bill of Materials, and PCB Pattern

3.1. Schematic

Refer to the following file. RD219-SCHEMATIC-xx.pdf (xx is the revision number.)

3.2. Bill of Materials

Refer to the following file. RD219-BOM-xx.pdf (xx is the revision number.)

3.3. PCB Pattern

Figure 3.1 shows the PCB pattern of this design. Refer to the following file: RD219-LAYER-xx.pdf (xx is the revision number.)



<Layer 1 Front>



<Layer 2 Back> Fig. 3.1 PCB Pattern Diagram (Top View)

4. Operation

4.1. Names and Functions of Components

4.1.1. Power Supply Input Terminals (AC-L, AC-N, GND_EARTH)

These are the AC power supply input terminals. Connect these to an AC stabilized power supply. Solder the power supply wires to the through hole terminals of 2.7 mm diameter. And, if necessary connect the Earth wire to the frame ground (GND_EARTH) terminal.



Fig. 4.1 AC Power Supply Input Terminals (AC-L, AC-N, GND_EARTH)

····· ··· ···· ·······················						
Terminal Name	Function	Remarks				
AC-L	L (Live)	Φ2.7 mm through hole				
AC-N	N (Neutral)	Φ2.7 mm through hole				
GND_EARTH	Frame Ground	Φ2.7 mm through hole				

Table 4.1 AC Power Supply Input Terminal Specifications

4.1.2. Fan Motor Connector (CN10)

This is the fan motor (motor ch.0) output connector. Three-phase pins of U/V/W are provided to connect to the three-phase brushless motor. This connector uses B5P5-VH (JST) or a compatible connector.



Fig. 4.2 Fan Motor Connector (CN10)

4.1.3. Compressor Connectors (CN-CMP)

These are the compressor (motor ch.1) connectors (output). Three-phase pins of U/V/W are provided to connect to the three-phase brushless motor. Each of these connectors uses a blade connector DJ6110-6.3x0.8 (Gocel) or a compatible connector.



Fig. 4.3 Compressor Connector (CN-CMP)

4.1.4. Four-Way Valve Connectors (CN-VL1, CN-VN1)

These connectors are used to connect a four-way valve. Software based relay control enables AC line input voltage to be output between CN-VL1 and CN-VN1 when it is ON. CN-VN1 is always connected to AC power input terminal AC-N. Each of these connectors uses a blade connector DJ6110-6.3x0.8 (Gocel) or a compatible connector.



Fig. 4.4 Four-Way Valve Connectors (CN-VL1, CN-VN1)

4.1.5. Electric Expansion Valve Connector (CN11)

This connector is used to connect the electric expansion valve. Four output channels EEV-A, EEV-B, EEV-C and EEV-D are controlled by software operated low-side switches, and the output of each channel is open when the corresponding switch is off and is connected to the GND when the corresponding switch is on. By connecting an electric expansion valve between a channel of EEV output and the 12 V power supply, the 12 V voltage is applied to the electric expansion valve when the switch is on. This connector uses B6B-XH-A (JST) or a compatible connector.



Fig. 4.5 Electric Expansion Valve Connector (CN11)

Pin	Function	Description
1	EEV-D control power	Connected to GND when on, open when off
2	EEV-C control power	Connected to GND when on, open when off
3	EEV-B control power	Connected to GND when on, open when off
4	EEV-A control power	Connected to GND when on, open when off
5	Power supply (12 V)	
6	Power supply (12 V)	

Table4.2 Electric Expansion Valve Connector (CN11) Specifications

4.1.6. Indoor Unit Communication Connector (CN-COM)

This connector is used in conjunction with AC power supply input terminal AC-N to perform serial communication with the indoor unit. Use the product according to the electrical laws and regulations of each country. This connector uses a blade connector DJ6110-6.3x0.8(Gocel) or a compatible connector.



Fig. 4.6 Indoor Unit Communication Connector (CN-COM)

4.1.7. AC Power Supply Fuse (F1)

This is an AC power supply fuse. This fuse has a rating of 250 VAC 20 A.



Fig. 4.7 AC Power Supply Fuse (F1)

4.1.8. Temperature Sensor Connectors (CN5, CN8, CN9)

CN5, CN8, CN9 are the temperature sensor connectors. A total of six channels of temperature sensors can be connected via the three connectors. Connect each NTC thermistor between the power supply (5 V) and the voltage output pin of each connector. The connector CN5 uses B6B-XH-A (JST), CN8 uses B4B-XH-A (JST), CN9 uses B2B-XH-A (JST), or compatible connectors.



Fig. 4.8 Temperature Sensor Connectors (CN5, CN8, CN9)

Pin	Description	Application Examples	
1	Temperature sensor ch.		
	0 voltage input	For measuring temperature in	
2	Temperature sensor ch.	equipment	
2	0 power supply (5 V)		
2	Temperature sensor ch.		
J	1 voltage input	For measuring temperature in	
4	Temperature sensor ch.	equipment	
4	1 power supply (5 V)		
E	Temperature sensor ch.		
5	2 voltage input	For measuring temperature in	
6	Temperature sensor ch.	equipment	
0	2 power supply (5 V)		

Table4.3 Temperature Sensor Connector (CN5) Specifications

Table4.4 Temperature Sensor Connector (CN8) Specifications

Pin	Description	Application Examples
1	Temperature sensor ch.	For measuring temperature of
2	Temperature sensor ch. 3 Power (5 V)	PFC IGBT
3	Temperature sensor ch. 4 voltage input	For measuring temperature of
4	Temperature sensor ch. 4 power supply (5 V)	PFC diode

Pin	Description	Application Examples
1	Temperature sensor	
L.	ch. 5 voltage input	For measuring temperature of
2	Temperature sensor	compressor-drive MOSFET
Z	ch. 5 Power (5 V)	

Table4.5 Temperature Sensor Connector (CN9) Specifications

4.1.9. UART Connector (CN3)

This connector is used to connect to the UART of the MCU included in this design. Connect to the host MCU board when checking the operation. This connector uses B6B-XH-A(JST) or a compatible connector.



Fig. 4.9 UART Connector (CN3)

Pin Number	Pin Name	Function	Host MCU Board Connection				
Number		CND					
1	DVSS	GND	GND (TB1 - GND)				
2	TXD	UART Tx	RXD (HDR1 – pin9)				
3	RXD	UART Rx	TXD (HDR1 – pin10)				
4	(n.c.)	-	-				
5	nRESET	Reset input	HDR1 – pin15				
6	DVDD	5 V output	TB1 (VCC-EXT)				

Table. 4.6 UART Connector (CN3) Specifications

4.1.10. SWD Connector (CN1)

This is the SWD (Serial Wire Debug) Connector. MCU used in this design can be debugged by connecting an external debugger. This connector uses B5B-XH-A (JST) or a compatible connector.



Fig. 4.10 SWD Connector (CN1)

Table. 4.7 SWD Connector (CN1) Specifications

Pin Number	Pin Name	Input/Output	Pin Description
1	DVSS	-	GND
2	(n.c.)	-	GPIO port
3	SWCLK	Ι	SWD clock signal (100 k Ω pull-up recommended)
4	SWDIO	I/O	SWD data signal (100 k Ω pull-up recommended)
5	DVDD	-	5 V power

4.1.11. DAC Output Connector (CN2)

This is a synchronous serial data output connector for an external DAC. The external DAC can be used to monitor the waveform. For example, software settings can be used to output the internal data. This connector uses B5B-XH-A (JST) or a compatible connector.



Fig. 4.11 DAC Output Connector (CN2)

Pin Number	Pin Name	Input/Output	Pin Description
1	DVDD		5 V voltage
2	SDIN	0	GPIO port
3	SCLK	0	SIO port
4	SYNC	0	SIO port
5	DVSS		GND

Table. 4.8 DAC Output Connector (CN2) Specifications

4.1.12. LEDs (LED1, LED2, LED3, LED4, LED5)

The operation status is displayed on the LED1, LED2, LED3, LED4 by the software. LED5 lights up when 5 V power is supplied.



Fig. 4.12 LEDs (LED1, LED2, LED3, LED4, LED5)

Table 4.9 LED Operation Specifications in Sample Software

Factor Type		LED Status	
Fan Motor (Motor ch.0)	Normal operation	LED1 turns off	
	Hardware error (overcurrent, etc.)	LED2 blinks 1 time	
	Soft overcurrent	LED2 blinks 2 times	
_	No error	LED1 turns off	
Compressor (Motor ch.1)	Hard overcurrent	LED3 blinks 1 time	
	Soft overcurrent	LED3 blinks 2 times	
	Normal operation	LED1 goes off	
	Hard overcurrent	LED4 blinks 1 time	
	Soft overcurrent	LED4 blinks 2 times	
	AC overvoltage	LED4 blinks 3 times	
PFC	AC undervoltage	LED4 blinks 4 times	
	DC overvoltage	LED4 blinks 5 times	
	DC undervoltage	LED4 blinks 6 times	
	AC voltage frequency error	LED4 blinks 7 times	
	Zero cross error	LED4 blinks 8 times	
	Normal operation	LED1 goes off	
Temperature	Sensor is open	LED1 blinks 1 time	
	Abnormal temperature	LED1 blinks 2 times	

4.1.13. Test Pins (TP)

In this design, the test pins are through holes with 1 mm diameters.

Test Pin	Signal Name	Description	
Name			
TP1	+15 V	Control power 15 V	
TP2	+12 V	Control power 12 V	
TP3	+5 V	Control power 5 V	
TP5	IAC_AD	PFC current sense amplifier	
TP6	PFC_FO	PFC overcurrent detected	
TP7	VAC_AD	AC voltage detection amplifier output	
TP8	PFC_PWM	Gate driver input signal for PFC	
TP10	IGBT_Drive	IGBT gating for PFC	
TP11	VDC_AD	DC voltage detection signal	
TP12	LED1	LED1 (L-level when lit)	
TP13	LED2	LED2 (L-level when lit)	
TP14	LED3	LED3 (L-level when lit)	
TP15	LED4	LED4 (L-level when lit)	
TP16	PWM_UH0	Motor ch.0 U phase high-side PWM	
TP17	PWM_VH0	Motor ch.0 V phase high-side PWM	
TP18	PWM_WH0	Motor ch.0 W phase high-side PWM	
TP19	PWM_UL0	Motor ch.0 U phase low-side PWM	
TP20	PWM_VL0	Motor ch.0 V phase low-side PWM	
TP21	PWM_WL0	Motor ch.0 W phase low-side PWM	
TP22	EMG0	Motor ch.0 error detection signal	
TP23	PWM_UH1	Motor ch.1 U phase high-side PWM	
TP24	PWM_VH1	Motor ch.1 V phase high-side PWM	
TP25	PWM_WH1	Motor ch.1 W phase high-side PWM	
TP26	PWM_UL1	Motor ch.1 U phase low-side PWM	
TP27	PWM_VL1	Motor ch.1 V phase low-side PWM	
TP28	PWM_WL1	Motor ch.1 W phase low-side PWM	
TP29	EMG1	Motor ch.1 Over Current Sensing	
TP30	GND	GND	
TP31	GND	GND	
TP32	GND	GND	
TP33	AVDD	Analog voltage 5 V	

Table 4.10 Test Pin Specifications

4.2. Operation

4.2.1. Preparation

MikroElektronika's <u>Clicker 4 for TMPM4K</u> is required as the host MCU board to verify the operation of this design.

Build the reference design sample software for operation verification and the host MCU sample software, and write them to this design and the host MCU board, respectively. The software has been developed and verified in the following environments and versions.

IAR Embedded Workbench for Arm[®] 9.32.2 Arm Keil MDK 5.38.0

These can be downloaded from the URLs given below.

IAR Embedded Workbench for Arm

https://www.iar.com/products/architectures/arm/iar-embedded-workbench-for-arm/ User registration is required when using the tool for the first time.

Arm Keil MDK

https://www.keil.com/arm/demo/eval/arm.htm

User registration is required for downloading.

Connect the host MCU board to UART connector (CN3) of this design using a cable. Refer to Table. 4.6 UART Connector (CN3) Specifications for more information on connection.

Connect CN1 of the host MCU board to the PC with an USB cable and start the terminal software on PC. The settings for the terminal software are 119200 bps, 8 bit, non parity and 1 stop bit. USB-UART device driver from FTDI must be installed on PC in advance. It can be downloaded from the following site.

https://ftdichip.com/drivers/d2xx-drivers/

4.2.2. Operation Checking Procedure

When AC power is applied to this design, 5 V power is also supplied to the host MCU board. Pressing the reset button on the host MCU board establishes UART communication between the host MCU board and this design.

You can control PFC and motors of this design by operating B1, B2, B3, B4, B5, B6 on the host MCU board. Pressing RST button resets the host MCU board and this design.



Fig. 4.13 Host MCU Board Operation Switches (RST, B1, B2, B3, B4, B5, B6)

Switch	Function	Description	
RST	Reset	Resets the host MCU board and this design	
B1	Motor/PFC Stop	Stops motor drive and PFC operation	
B2	PFC operation switching	Switches PFC operation on/off	
B3	Motor switching Switches the motor for controlling the rotation speed.		
B4	Motor speed increase	Increases (+10 Hz) the rotational speed. (Higher limit 120 Hz)	
B5	Motor speed Decreases (-10 Hz) the rotational speed. (Lower limit 60 H decrease		
В6	Sends the status output to the terminal software connected via USB-UART. Press and hold (for 3 seconds) to switch the stat Fan motor (motor ch.0) \rightarrow Compressor (motor fan motor (motor ch.0) \rightarrow ••••		

Tab. 4.11 Host MCU Board Switch Function in Sample Software

4.2.3. Operation During Abnormality Detection

·UART Communication Error

UART communication error between the host MCU board and this design is judged according to the following conditions.

(1) If the design fails to receive commands from the host MCU board that are sent periodically for two seconds

(2) If the host MCU board fails to send commands ten consecutive times

- (3) When there is no answer between 100 ms from this design
- (4) When there is a Nack response (no response) from this design

When a communication error occurs, LED(L1) on the host MCU board flashes in 250 ms cycles. To clear a communication error, reset the host MCU board and this design by pressing RST switch on the host MCU board.

•Exception Error

If any of the following factors is detected, this design goes to EMG (Emergency) state, and all the motors and the PFC are stopped. Pressing MCU board B1 switch (Motor/PFC Stop) or RST switch (Reset) releases EMG state.

Factors		Factor Details	This Design LED Status	Host MCU Board LED Status
Fan Motors	Hardware	Overcurrent, overheat, etc. are detected	LED2 blinks 1	L4 flaching
(Motor	Soft	Dy MCU hardware function	LED2 blipke 2	
ch.0)	overcurrent	processing	times	flashing
Compressor (Motor ch1)	Hard	Overcurrent is detected by MCU	LED3 blinks 1	L5 flashing
	Soft	Overcurrent is detected by software	LED3 blinks 2 times	L5 flashing
PFC	Hard overcurrent	Overcurrent is detected by MCU hardware function	LED4 blinks 1 time	L6 flashing
	Soft overcurrent	Overcurrent is detected by software processing	LED4 blinks 2 times	L6 flashing
	AC overvoltage	AC overvoltage is detected by software processing	LED4 blinks 3 times	L6 flashing
	AC undervoltage	AC undervoltage detected by software processing	LED4 blinks 4 times	L6 flashing
	DC overvoltage	DC overvoltage is detected by software processing	LED4 blinks 5 times	L6 flashing
	DC undervoltage	DC undervoltage detected by software processing	LED4 blinks 6 times	L6 flashing
	AC voltage frequency error	A frequency error of AC voltage is detected by software processing	LED4 blinks 7 times	L6 flashing
	Zero cross error	A zero crossing error of AC voltage is detected by the software processing	LED4 blinks 8 times	L6 flashing

Table 4.12 Error Detection Operation in Sample Software

4.3. Precautions (To Prevent Electric Shock, Burn Injury, etc.)

Pay special attention to the following when checking the operation.

- Make sure that the equipment is connected properly before turning on the power.
- Connect the connectors and terminals without mistake.

• Do not touch any component of the board while the power is on, as there is a risk of an electric shock.

• It takes time for the smoothing capacitor of the power supply, etc., to completely discharge. Do not touch the circuit board until it is fully discharged after the power is turned off.

• When checking the operation, cover the BOARD with an acrylic case for safety.

• Some components become hot during operation. Be careful not to get burned while handling them.

※ Arm is registered trademarks of Arm Limited (or its subsidiaries) in the US and/or elsewhere.
※ Other company names, product names, and service names may be trademarks of their respective companies.

Terms of Use

This terms of use is made between Toshiba Electronic Devices and Storage Corporation ("We") and Customer who downloads or uses this Reference Design. Customer shall comply with this terms of use. This Reference Design means all documents and data in order to design electronics applications on which our semiconductor device is embedded.

Section 1. Restrictions on usage

 This Reference Design is provided solely as reference data for designing electronics applications. Customer shall not use this Reference Design for any other purpose, including without limitation, verification of reliability.
 Customer shall not use this Reference Design for sale, lease or other transfer.

3. Customer shall not use this Reference Design for evaluation in high or low temperature, high humidity, or high electromagnetic environments.

4. This Reference Design shall not be used for or incorporated into any product or system whose manufacture, use, or sale is prohibited under any applicable laws or regulations.

Section 2. Limitations

1. We reserve the right to make changes to this Reference Design without notice.

2. This Reference Design should be treated as a reference only. WE ARE NOT RESPONSIBLE FOR ANY INCORRECT OR INCOMPLETE DATA AND INFORMATION.

 Semiconductor devices can malfunction or fail. When designing electronics applications by referring to this Reference Design, Customer is responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of semiconductor devices could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Customer must also refer to and comply with the latest versions of all relevant our information, including without limitation, specifications, data sheets and application notes for semiconductor devices, as well as the precautions and conditions set forth in the "Semiconductor Reliability Handbook".
 Designing electronics applications by referring to this Reference Design, Customer must evaluate the whole system sufficiently. Customer is solely responsible for applying this Reference Design to Customer's own product design or applications. WE ASSUME NO LIABILITY FOR CUSTOMER'S PRODUCT DESIGN OR APPLICATIONS.
 WE SHALL NOT BE RESPONSIBLE FOR ANY INFRINGEMENT OF PATENTS OR ANY OTHER INTELLECTUAL PROPERTY RIGHTS OF THIRD PARTIES THAT MAY RESULT FROM THE USE OF THIS REFERENCE DESIGN. NO LICENSE TO ANY INTELLECTUAL PROPERTY RIGHT IS GRANTED BY THIS TERMS OF USE, WHETHER EXPRESS OR

IMPLIED, BY ESTOPPEL OR OTHERWISE. 6. THIS REFERENCE DESIGN IS PROVIDED "AS IS". WE (a) ASSUME NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (b) DISCLAIM ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO THIS REFERENCE DESIGN, INCLUDING WITHOUT LIMITATION, WARRANTIES OR CONDITIONS OF FUNCTION AND WORKING, WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.

Section 3. Terms and Termination

It is assumed that Customer agrees to any and all this terms of use if Customer downloads or uses this Reference Design. We may, at its sole and exclusive discretion, change, alter, modify, add, and/or remove any part of this terms of use at any time without any prior notice. We may terminate this terms of use at any time and without any cause. Upon termination of this terms of use, Customer shall eliminate this Reference Design. Furthermore, upon our request, Customer shall submit to us a written confirmation to prove elimination of this Reference Design.

Section 4. Export Control

Customer shall not use or otherwise make available this Reference Design for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). This Reference Design may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Act and the U.S. Export Administration Regulations. Export and re-export of this Reference Design is strictly prohibited except in compliance with all applicable export laws and regulations.

Section 5. Governing Laws

This terms of use shall be governed and construed by laws of Japan, without reference to conflict of law principle.

Section 6. Jurisdiction

Unless otherwise specified, Tokyo District Court in Tokyo, Japan shall be exclusively the court of first jurisdiction for all disputes under this terms of use.